

Atty Dkt. No.: SERA-001  
USSN: 10/817,319

## **AMENDMENTS**

### **IN THE SPECIFICATION**

**Please amend paragraph 0035 as follows:**

[0035] Yet, whether the spacer is a powdered metal piece or otherwise formed, more aggressive forming techniques can be applied to reduce any gaps between the sensor and facing material. Particularly, a hydroforming procedure such as described in the '365 patent referenced above may be employed. It should be noted that such forming techniques should not apply forces on sensor 2 sufficient to generate electrical resistance changes caused by strains in sensor number 2. Our tests have shown that with simple mechanical compression of a powdered metal copper spacer and release from the compression, sensor 2 is not easily pressed from hole 20 22 (when opened at a distal end 24 to allow such action).